## 503655387 01/20/2016

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3702021

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
PARIJAT BISWAS	12/23/2015
SHYAM DATTA	01/12/2016
SUBHRAJYOTI CHAKRABORTY	12/18/2015
MINAKSHI CHAKRAVORTY	12/23/2015

## **RECEIVING PARTY DATA**

Name:	SYNOPSYS, INC.
Street Address:	690 EAST MIDDLEFIELD ROAD
City:	MOUNTAIN VIEW
State/Country:	CALIFORNIA
Postal Code:	94043

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14882414

## **CORRESPONDENCE DATA**

**Fax Number:** (650)938-5200

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 6503357607

Email: aeidinger@fenwick.com

Correspondent Name: RAJIV P. PATEL

Address Line 1: FENWICK & WEST LLP
Address Line 2: 801 CALIFORNIA STREET

Address Line 4: MOUNTAIN VIEW, CALIFORNIA 94041

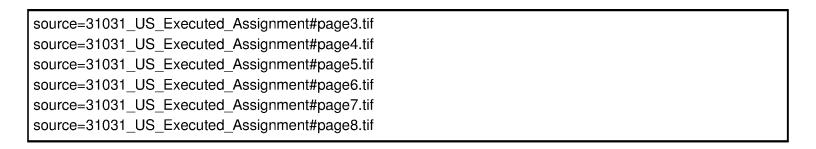
ATTORNEY DOCKET NUMBER: 22524-31031/US	
NAME OF SUBMITTER:	RAJIV P. PATEL, REG. NO. 39,327
SIGNATURE:	/Rajiv P. Patel/
DATE SIGNED:	01/20/2016

## **Total Attachments: 8**

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PATENT REEL: 037527 FRAME: 0587



PATENT REEL: 037527 FRAME: 0588

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to **Synopsys**, **Inc.**, a Delaware Corporation, having a place of business at 690 East Middlefield Road, Mountain View, CA 94043 ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

- 1. The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the following provisional or non-provisional application filed under 35 U.S.C. § 111, design application filed under 35 U.S.C. § 171, international application filed according to the Patent Cooperation Treaty (PCT), or U.S. national phase application filed under 35 U.S.C. § 371 ("APPLICATION"):
  - Application No. 14/882,414, entitled "Signal Reconstruction in Sequential Logic Circuitry," filed on October 13, 2015.
  - 2. The entire worldwide right, title, and interest in and to:
- (a) the APPLICATION; (b) all applications claiming priority from the APPLICATION; (c) all provisional, utility, divisional, continuation, substitute, renewal, reissue, and other applications related thereto that have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) that may be granted on the applications set forth in (a), (b), and (c) above; and (e) all right of priority in the APPLICATION and in any underlying provisional or foreign application, together with all rights to recover damages for infringement of provisional rights.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

Lof 2

Title:	Signal Reconstruction in Sequen	itial Logic Circuitry		
Filed:	October 13, 2015	Attorney	22524-31031/US	•
Application #:	14/882,414	Docket #: 2609US01	P2015,0735 US E	1

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

By signing below, INVENTOR further attests to the following:

- The APPLICATION was made or authorized to be made by INVENTOR.
- INVENTOR believes that INVENTOR is the original inventor or an original joint inventor of a claimed invention in the APPLICATION.

INVENTOR hereby acknowledges that any willful false statement made in this document is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Name and Signature		Date of Signature
	2	, <del></del>
Parijat Biswas		
Name and Signature		Date of Signature
Shyam Datta		
Name and Signature		Date of Signature
<u>Interagedi Chakenbety</u> Subhrajyoti Chakraburty		18/12/15
CHAPTAN MAY CON CIRCUX GROWN LY		
Name and Signature		Date of Signature
Minakshi Chakrayorty		***************************************

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Title:	Signal Reconstruction in Sequent	tial Logic Circuitry	wo water few	
Filed:	October 13, 2015	Attorney	22524-31031/US	
		Docket #:		
Application #:	14/882,414	2609US01	P2015,0735 US E	-

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Name and Signature	Date of Signature
Parattonian	December 23, 2015
Parijat Biswas	
Name and Signature	Date of Signature
Shyam Datta	
Name and Signature	Date of Signature
Subhrajyoti Chakraborty	
Name and Signature	Date of Signature
Minakshi Chakravortv	

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Filed:	October 13, 2015	Attorney	22524-31031/US	
		Docket #:		
Application #		2609US01	P2015,0735 US E	-

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Name and Signature	Date of Signature	
Parijat Biswas		
Name and Signature	Date of Signature	
Shyam Datta		
Name and Signature	Date of Signature	
Subhrajyoti Chakraborty		
Name and Signature	Date of Signature	
Minalyti Chadosavardy Minakshi Chakravarty	December 23, 2015	

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Name and Signature  Shyam Datta  Shyam Datta	Date of Signature
Name and Signature	Date of Signature
Subhrajyoti Chakraborty	
Name and Signature	Date of Signature
Minakshi Chakrayartu	***************************************

2 of 2